

## Engineering Development Model

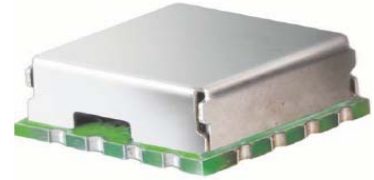
# Low Pass Filter

# RLPF-EDU1086

## Surface Mount

### Important Note

This model has been designed, built and tested in our engineering department. Performance data represents model capability. At present it is a non-catalog model. On request, we can supply a final specification sheet, part number and price/delivery information.



Please click "Back", and then click "Contact Us" for Applications support.

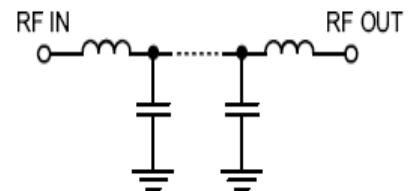
CASE STYLE : CK605

### ELECTRICAL SPECIFICATIONS 50Ω @ +25°C

| Parameter                   | Min.  | Typ. | Max. | Units |
|-----------------------------|-------|------|------|-------|
| Passband<br>(Loss < 2.5 dB) | DC    |      | 1800 | MHz   |
| Insertion loss 3dB          |       | 1850 |      | MHz   |
| Stopband<br>(Loss > 20 dB)  | @2075 |      |      | MHz   |
| (Loss > 25 dB)              | 2100  |      | 4000 | MHz   |
| Passband VSWR               |       | 1.4  | 2.1  | (:1)  |
| Stopband VSWR               |       | 20   |      | (:1)  |

### Functional Schematic

| MAXIMUM RATINGS       |                |
|-----------------------|----------------|
| Operating Temperature | -40°C to 85°C  |
| Storage Temperature   | -55°C to 100°C |
| RF Power Input        | 10mW           |



### PIN CONNECTIONS

|               |                                |
|---------------|--------------------------------|
| Input         | 2                              |
| Output        | 10                             |
| Not Connected | 14                             |
| Case Ground   | 1,3,4,5,6,7,8,9,11,12,13,15,16 |



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RF/IF MICROWAVE COMPONENTS



REV. X1

RLPF-EDU1086+

URJ

080605

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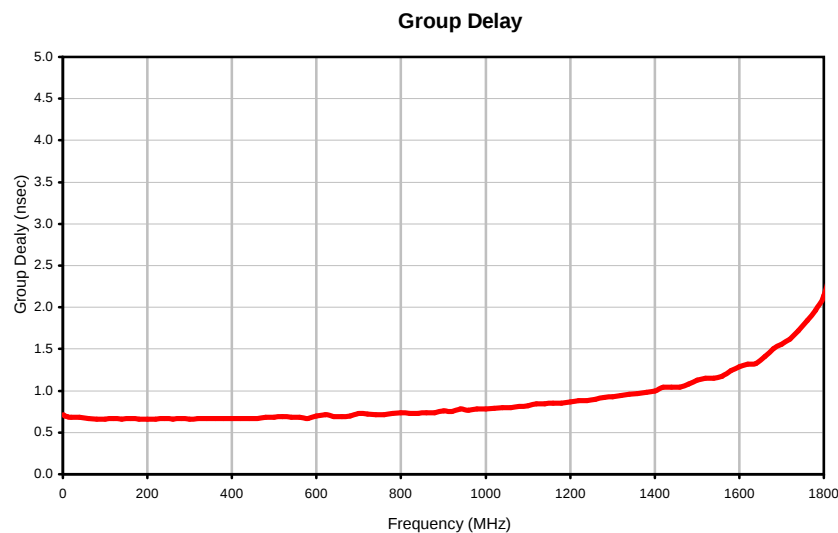
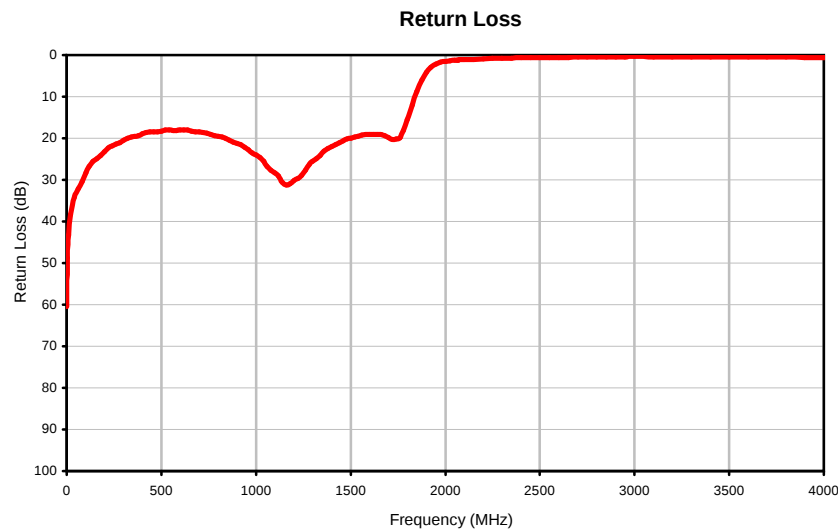
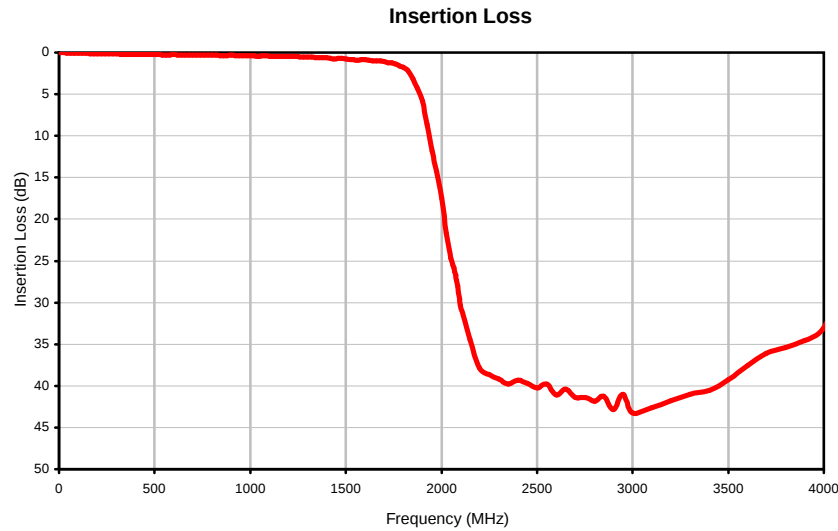
# Low Pass Filter

## RLPF-EDU1086

### Typical Performance Data

| FREQUENCY<br>(MHz) | INSERTION<br>LOSS<br>(dB) | RETURN<br>LOSS<br>(dB) | FREQUENCY<br>(MHz) | GROUP<br>DELAY<br>(nsec) |
|--------------------|---------------------------|------------------------|--------------------|--------------------------|
| 1.0                | 0.00                      | 60.47                  | 1.0                | 0.71                     |
| 5.0                | 0.01                      | 48.76                  | 10.0               | 0.69                     |
| 20.0               | 0.02                      | 38.32                  | 40.0               | 0.68                     |
| 40.0               | 0.04                      | 34.08                  | 100.0              | 0.66                     |
| 80.0               | 0.07                      | 30.39                  | 200.0              | 0.66                     |
| 100.0              | 0.09                      | 28.36                  | 300.0              | 0.66                     |
| 200.0              | 0.14                      | 23.27                  | 400.0              | 0.67                     |
| 500.0              | 0.26                      | 18.24                  | 500.0              | 0.68                     |
| 1000.0             | 0.37                      | 24.00                  | 600.0              | 0.70                     |
| 1500.0             | 0.77                      | 19.94                  | 700.0              | 0.73                     |
| 1700.0             | 1.11                      | 19.87                  | 800.0              | 0.74                     |
| 1800.0             | 1.77                      | 15.53                  | 900.0              | 0.76                     |
| 1825.0             | 2.16                      | 11.97                  | 1000.0             | 0.78                     |
| 1850.0             | 3.15                      | 8.72                   | 1060.0             | 0.80                     |
| 1900.0             | 5.86                      | 4.13                   | 1100.0             | 0.82                     |
| 1950.0             | 11.82                     | 2.20                   | 1200.0             | 0.87                     |
| 2000.0             | 17.48                     | 1.50                   | 1240.0             | 0.88                     |
| 2025.0             | 21.64                     | 1.37                   | 1300.0             | 0.93                     |
| 2075.0             | 26.74                     | 1.15                   | 1400.0             | 1.00                     |
| 2100.0             | 30.33                     | 1.11                   | 1500.0             | 1.13                     |
| 2500.0             | 40.27                     | 0.63                   | 1540.0             | 1.15                     |
| 3000.0             | 43.25                     | 0.35                   | 1600.0             | 1.29                     |
| 3500.0             | 39.23                     | 0.39                   | 1700.0             | 1.56                     |
| 4000.0             | 33.01                     | 0.60                   | 1800.0             | 2.14                     |

## Typical Performance Curves



## Outline Dimensions

CK605

## PCB Land Pattern



Suggested Layout,  
Tolerance to be within  $\pm .002$

| CASE # | A               | B               | C              | D              | E              | F              | G              | H              | J               | K              |
|--------|-----------------|-----------------|----------------|----------------|----------------|----------------|----------------|----------------|-----------------|----------------|
| CK605  | .500<br>(12.70) | .500<br>(12.70) | .180<br>(4.57) | .100<br>(2.54) | .080<br>(2.03) | .115<br>(2.92) | .060<br>(1.52) | .040<br>(1.02) | .540<br>(13.72) | .060<br>(1.52) |

| CASE # | L              | M              | N              | P              | Q              | R              | S              | T              | WT. GRAM            |
|--------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|---------------------|
| CK605  | .100<br>(2.54) | .135<br>(3.43) | .135<br>(3.43) | .115<br>(2.92) | .140<br>(3.56) | .070<br>(1.78) | .150<br>(3.81) | .070<br>(1.78) | 1.2<br>+0.5<br>-0.0 |

Dimensions are in inches (mm). Tolerances: 2 Pl.  $\pm .03$ ; 3Pl.  $\pm .015$

### Notes:

- Case material: Nickel-Silver alloy.
- Base: Printed wiring laminate.
- Termination finish:  
For RoHS Case Styles: 3-5  $\mu$  inch (.08-.13 microns) Gold over 120-240  $\mu$  inch (3.05-6.10 microns) Nickel plate.  
All models, (+) suffix.



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RF/IF MICROWAVE COMPONENTS

# Tape & Reel Packaging TR-F37



| Tape Width, mm | Device Cavity Pitch, mm | Reel Size, inches | Devices per Reel                    |     |
|----------------|-------------------------|-------------------|-------------------------------------|-----|
| 24             | 16                      | 7                 | Small quantity standards (see note) | 10  |
|                |                         |                   |                                     | 20  |
|                |                         |                   |                                     | 50  |
|                |                         |                   |                                     | 100 |
|                |                         | 13                | Standard                            | 200 |
|                |                         |                   |                                     | 500 |

Note: Please consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

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Mini-Circuits ISO 9001 & ISO 14001 Certified



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

| Specification                 | Test/Inspection Condition                                                                                                 | Reference/Spec                                |
|-------------------------------|---------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------|
| Operating Temperature         | -40° to 85° C<br>Ambient Environment                                                                                      | Individual Model Data Sheet                   |
| Storage Temperature           | -65° to 150° C<br>Ambient Environment                                                                                     | Individual Model Data Sheet                   |
| Autoclave                     | 15 psig, 100% RH, 121°C, 96 hours                                                                                         | JESD22-A102-C, Condition C                    |
| Temperature Cycling           | -65° to 150°C, 100 cycles                                                                                                 | JESD22-A104                                   |
| Temperature Humidity          | 85°C/ 85% RH, 168 hours                                                                                                   | JESD22-113                                    |
| Solder Reflow Heat            | Sn-Pb Eutetic Process: 240°C peak<br>Pb-Free Process: 260°C peak                                                          | J-STD-020, Table 4-1, 4-2 and 5-2; Figure 5-1 |
| Moisture Sensitivity: Level 1 | Bake at 125°C for 24 hours<br>Soak at 85°C/85% RH for 168 hours, Reflow 3 cycles at 240°C peak (Non-RoHS) or 260°C (RoHS) | J-STD-020                                     |
| Solderability                 | 10X magnification, 95% coverage                                                                                           | JESD22-B102, Method 1: Dip and Look Test      |
| Mechanical Shock              | 50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes                                                         | MIL-STD-202, Method 213, Condition A          |
| Vibration (High Frequency)    | 20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)                                       | MIL-STD-202, Method 204, Condition D          |